

KK74HCT14A

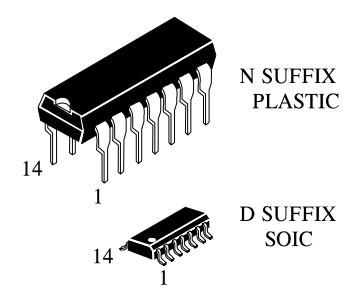
**Hex Schmitt-Trigger Inverter
High-Performance Silicon-Gate CMOS**

The KK74HCT14A may be used as a level converter for interfacing TTL or NMOS outputs to high-speed CMOS inputs.

The KK74HCT14A is identical in pinout to the LS/ALS14.

The KK74HCT14A is useful to "square up" slow input rise and fall times. Due to the hysteresis voltage of the Schmitt trigger, the KK74HCT14A finds applications in noisy environments.

- TTL/NMOS-Compatible Input Levels.
- Outputs Directly Interface to CMOS, NMOS and TTL.
- Operating Voltage Range: 4.5 to 5.5 V
- Low Input Current: 1.0 μ A

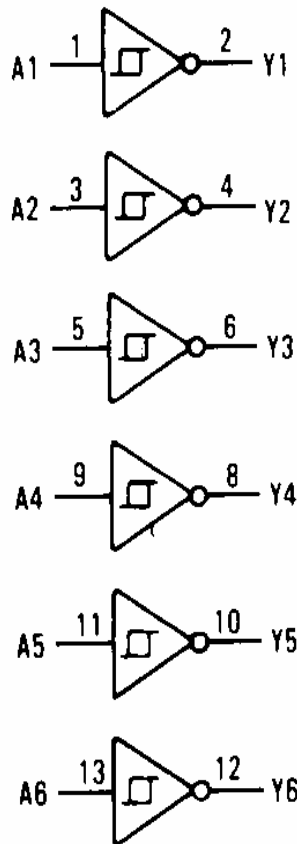


N SUFFIX
PLASTIC

D SUFFIX
SOIC

ORDERING INFORMATION
 KK74HCT14AN Plastic
 KK74HCT14AD SOIC
 $T_A = -55^\circ$ to 125° C for all packages

LOGIC DIAGRAM



$Y = \bar{A}$

PIN 14 = V_{CC}
 PIN 7 = GND

PIN ASSIGNMENT

A1	1	14	V_{CC}
Y1	2	13	A6
A2	3	12	Y6
Y2	4	11	A5
A3	5	10	Y5
Y3	6	9	A4
GND	7	8	Y4

FUNCTION TABLE

Inputs	Output
A	Y
L	H
H	L

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
V _{IN}	DC Input Voltage (Referenced to GND)	-1.5 to V _{CC} +1.5	V
V _{OUT}	DC Output Voltage (Referenced to GND)	-0.5 to V _{CC} +0.5	V
I _{IN}	DC Input Current, per Pin	±20	mA
I _{OUT}	DC Output Current, per Pin	±25	mA
I _{CC}	DC Supply Current, V _{CC} and GND Pins	±50	mA
P _D	Power Dissipation in Still Air, Plastic DIP+ SOIC Package+	750 500	mW
T _{stg}	Storage Temperature	-65 to +150	°C
T _L	Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP or SOIC Package)	260	°C

*Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

+Derating - Plastic DIP: - 10 mW/°C from 65° to 125°C

SOIC Package: : - 7 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
	DC Supply Voltage (Referenced to GND)	4.5	5.5	V
V _{IN} , V _{OUT}	DC Input Voltage, Output Voltage (Referenced to GND)	0	V _{CC}	V
T _A	Operating Temperature, All Package Types	-55	+125	°C
t _r , t _f	Input Rise and Fall Time (Figure 1)	0	No Limit*	ns

* When V_{IN} ≈ 50% V_{CC}, I_{CC} > 1.0 mA.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{IN} and V_{OUT} should be constrained to the range GND ≤ (V_{IN} or V_{OUT}) ≤ V_{CC}.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

Symbol	Parameter	Test Conditions	V _{CC} V	Guaranteed Limit			Unit
				25 °C to -55°C	≤85 °C	≤125 °C	
V _{T+max}	Maximum Positive-Going Input Threshold Voltage	V _{OUT} =0.1 V I _{OUT} ≤ 20 μA	4.5 5.5	1.9 2.1	1.9 2.1	1.9 2.1	V
V _{T+min}	Minimum Positive-Going Input Threshold Voltage	V _{OUT} =0.1 V I _{OUT} ≤ 20 μA	4.5 5.5	1.2 1.4	1.2 1.4	1.2 1.4	V
V _{T-max}	Maximum Negative-Going Input Threshold Voltage	V _{OUT} =V _{CC} -0.1 V I _{OUT} ≤ 20 μA	4.5 5.5	1.2 1.4	1.2 1.4	1.2 1.4	V
V _{T-min}	Minimum Negative-Going Input Threshold Voltage	V _{OUT} =V _{CC} -0.1 V I _{OUT} ≤ 20 μA	4.5 5.5	0.5 0.6	0.5 0.6	0.5 0.6	V
V _{Hmax} Note 1	Maximum Hysteresis Voltage	V _{OUT} =0.1 V or V _{CC} -0.1V I _{OUT} ≤ 20 μA	4.5 5.5	1.4 1.5	1.4 1.5	1.4 1.5	V
V _{Hmin} Note 1	Minimum Hysteresis Voltage	V _{OUT} =0.1 V or V _{CC} -0.1V I _{OUT} ≤ 20 μA	4.5 5.5	0.4 0.4	0.4 0.4	0.4 0.4	V
V _{OH}	Minimum High-Level Output Voltage	V _{IN} ≤V _T -min I _{OUT} ≤ 20 μA	4.5 5.5	4.4 5.4	4.4 5.4	4.4 5.4	V
		V _{IN} ≤V _T -min I _{OUT} ≤4mA	4.5	3.98	3.84	3.7	
V _{OL}	Maximum Low-Level Output Voltage	V _{IN} ≥V _T +max I _{OUT} ≤ 20 μA	4.5 5.5	0.1 0.1	0.1 0.1	0.1 0.1	V
		V _{IN} ≥V _T +max I _{OUT} ≤ 4mA	4.5	0.26	0.33	0.4	
I _{IN}	Maximum Input Leakage Current	V _{IN} =V _{CC} or GND	5.5	±0.1	±1.0	±1.0	μA
I _{CC}	Maximum Quiescent Supply Current (per Package)	V _{IN} =V _{CC} or GND I _{OUT} =0μA	5.5	1.0	10	40	μA
ΔI _{CC}	Additional Quiescent Supply Current	V _{IN} =2.4 V, Any One Input V _{IN} =V _{CC} or GND, Other Inputs I _{OUT} =0 μA	5.5	≥-55° C	25°C to 125 °C		mA
				2.9	2.4		

Note: 1 V_{Hmin}>(V_{T+min})-(V_{T-max}); V_{Hmax}=(V_{T+max})-(V_{T-min})

AC ELECTRICAL CHARACTERISTICS ($V_{CC}=5.0\text{ V} \pm 10\%$, $C_L=50\text{pF}$, Input $t_r=t_f=6.0\text{ ns}$)

Symbol	Parameter	Temperature Limits			Unit
		25 °C to -55°C	≤85°C	≤125°C	
t_{PLH}, t_{PHL}	Maximum Propagation Delay, Input A or B to Output Y (L to H) (Figures 1 and 2)	32	40	48	ns
t_{TLH}, t_{THL}	Maximum Output Transition Time, Any Output (Figures 1 and 2)	15	19	22	ns
C_{IN}	Maximum Input Capacitance	10	10	10	pF

C_{PD}	Power Dissipation Capacitance (Per Inverter) Used to determine the no-load dynamic power consumption: $P_D=C_{PD}V_{CC}^2f+I_{CC}V_{CC}$	Typical @25°C, $V_{CC}=5.0\text{ V}$		pF
		32		

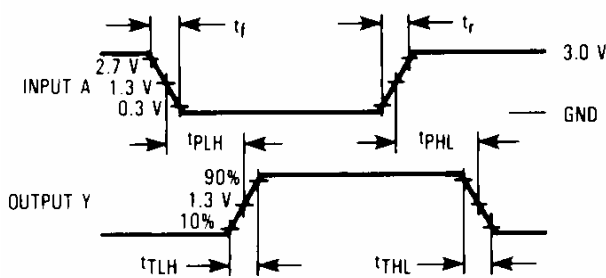
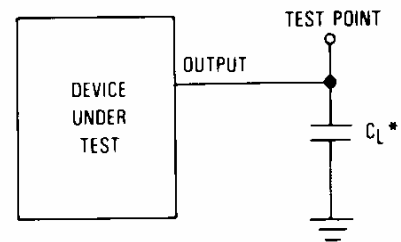


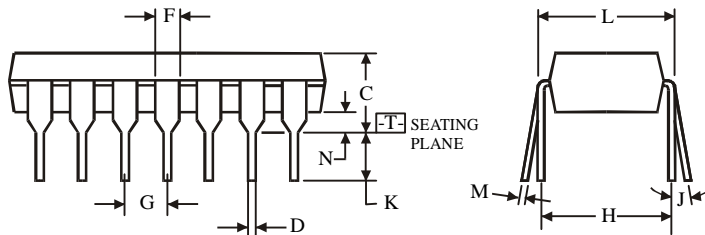
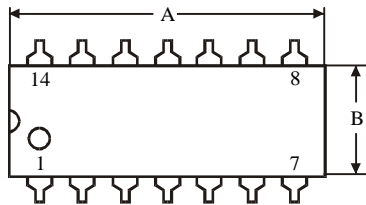
Figure 1. Switching Waveforms



*Includes all probe and jig capacitance.

Figure 2. Test Circuit

N SUFFIX PLASTIC DIP (MS - 001AA)



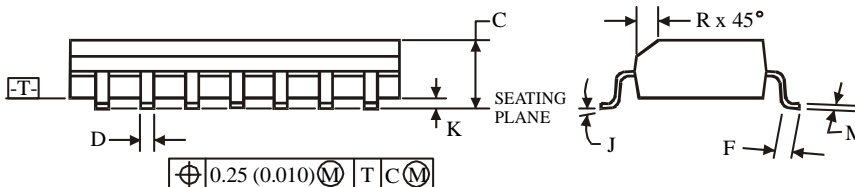
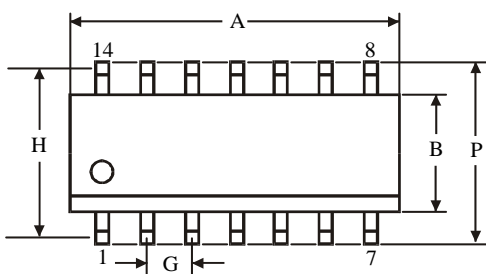
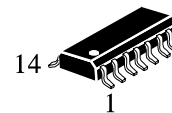
$\oplus 0.25 (0.010) \text{ (M) T}$

NOTES:

- Dimensions "A", "B" do not include mold flash or protrusions.
Maximum mold flash or protrusions 0.25 mm (0.010) per side.

Symbol	Dimension, mm	
	MIN	MAX
A	18.67	19.69
B	6.1	7.11
C		5.33
D	0.36	0.56
F	1.14	1.78
G	2.54	
H	7.62	
J	0°	10°
K	2.92	3.81
L	7.62	8.26
M	0.2	0.36
N	0.38	

D SUFFIX SOIC (MS - 012AB)



$\oplus 0.25 (0.010) \text{ (M) T C (M)}$

NOTES:

- Dimensions A and B do not include mold flash or protrusion.
- Maximum mold flash or protrusion 0.15 mm (0.006) per side for A; for B - 0.25 mm (0.010) per side.

Symbol	Dimension, mm	
	MIN	MAX
A	8.55	8.75
B	3.8	4
C	1.35	1.75
D	0.33	0.51
F	0.4	1.27
G	1.27	
H	5.27	
J	0°	8°
K	0.1	0.25
M	0.19	0.25
P	5.8	6.2
R	0.25	0.5